Customer Information Notification | 201710028I

Issue Date: 15-Jan-2018
Effective Date: 16-Jan-2018

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

QUALITY

Change Category

[ ] Wafer Fab Process	[ ] Assembly Process	[ ] Product Marking	[ ] Test Location	[ ] Design
[ ] Wafer Fab Materials	[ ] Assembly Materials	[ ] Mechanical Specification	[ ]Test Process	[ ] Errata
[ ] Wafer Fab Location	[ ] Assembly Location	[ ] Packing/Shipping/Labeling	[ ] Test Equipment	[X] Electrical spec./Test coverage

MPC5604B/C Data Sheet Update to Rev 14, MPC5606B Data Sheet Update to Rev 5 and MPC5607B Data Sheet Update to Rev 9

Information Notification

NXP Semiconductors announces a data sheet update for the MPC5604B/C to revision 14, MPC5606B to revision 5 and MPC5607B to revision 9. The revision history included in the updated document provides a detailed description of the changes.

Changes are summarized in the attached file with this notification.

The MPC5604B/C data sheet revision 14 is attached to this notice, and can be found at:
https://www.nxp.com/docs/en/data-sheet/MPC5604BC.pdf
The MPC5606B data sheet revision 5 is attached to this notice, and can be found at:
https://www.nxp.com/docs/en/data-sheet/MPC5606B.pdf
The MPC5607B data sheet revision 9 is attached to this notice, and can be found at:
https://www.nxp.com/docs/en/data-sheet/MPC5607B.pdf

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-03
Why do we issue this Information Notification
The data sheet has been updated to correct errors and provide additional technical clarification on some device features.

Identification of Affected Products
Product identification does not change

Impact

no impact to the product's functionality anticipated.
Data Sheet Revision
A new datasheet will be issued

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:
Name   Rong Kuen Ng
Position   Product Engineer
e-mail address ron.ng@nxp.com
At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.
Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Name	Status	Product Line
SPC5604BF2MLL6	935323074557	SPC5604BF2MLL6	512K FLASH,32K RAM,64MHz	LQFP100	RFS	BL Auto Micro Processors
SPC5604BK0MLQ6	935312078557	SPC5604BK0MLQ6	512K FLASH,32K RAM,64MHz	LQFP144	RFS	BL Auto Micro Processors
SPC5606BF1MLQ6	935317318557	SPC5606BF1MLQ6	BOLERO 1.5M CUT 2.2	LQFP144	RFS	BL Auto Micro Processors
SPC5605BF1VLQ6	935319612557	SPC5605BF1VLQ6	32Bit,768K FLASH,64K RAM	LQFP144	RFS	BL Auto Micro Processors
SPC5607BF1MLU6	935314466557	SPC5607BF1MLU6	32BIT 1.5M FLASH 96K RAM	LQFP176	RFS	BL Auto Micro Processors